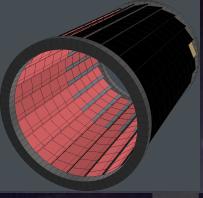


Agenda

- 9:00 FGT status and plans for the next 6 months
Doug Hasell**
- 9:25 IST status and plans for the next 6 months
Gerrit van Nieuwenhuizen**
- 9:45 Status and work planning Miro**
- 10:00 Status and work planning Dale**
- 10:15 Status and work planning Jim**

IST Status and Plans

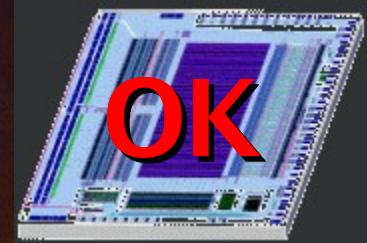
**Gerrit van Nieuwenhuizen
FGT/IST-MIT meeting
Bates, October 2, 2008**



IST FY08 R&D Prototyping



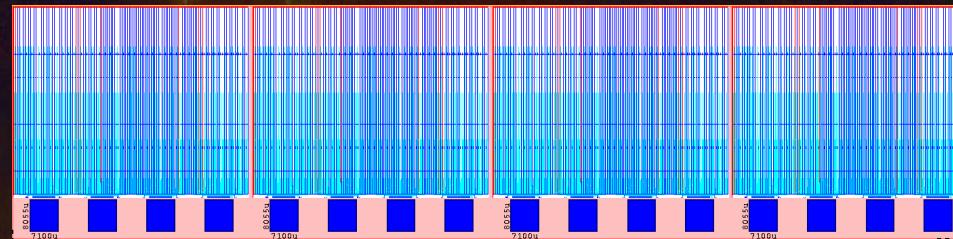
Carbon-Carbon



APV25-S1

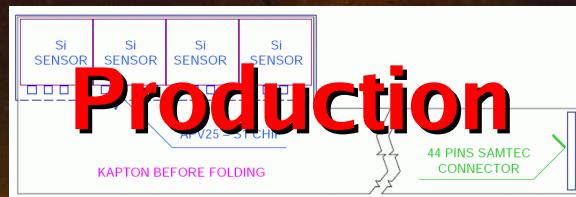


CF Ladder



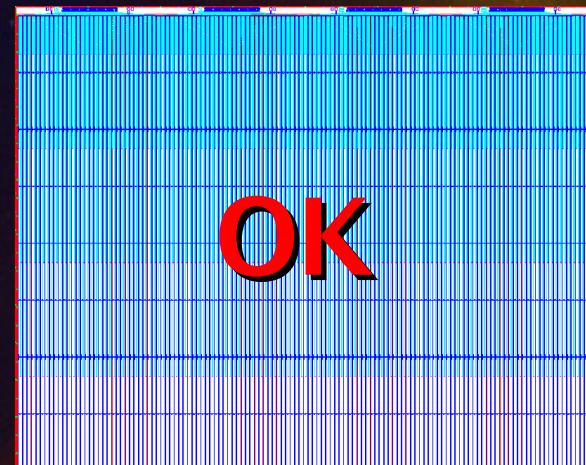
FY08 IST prototype module & ladder

PHOBOS IV sensors

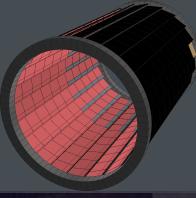


Kapton hybrid-cable

PrePrototype

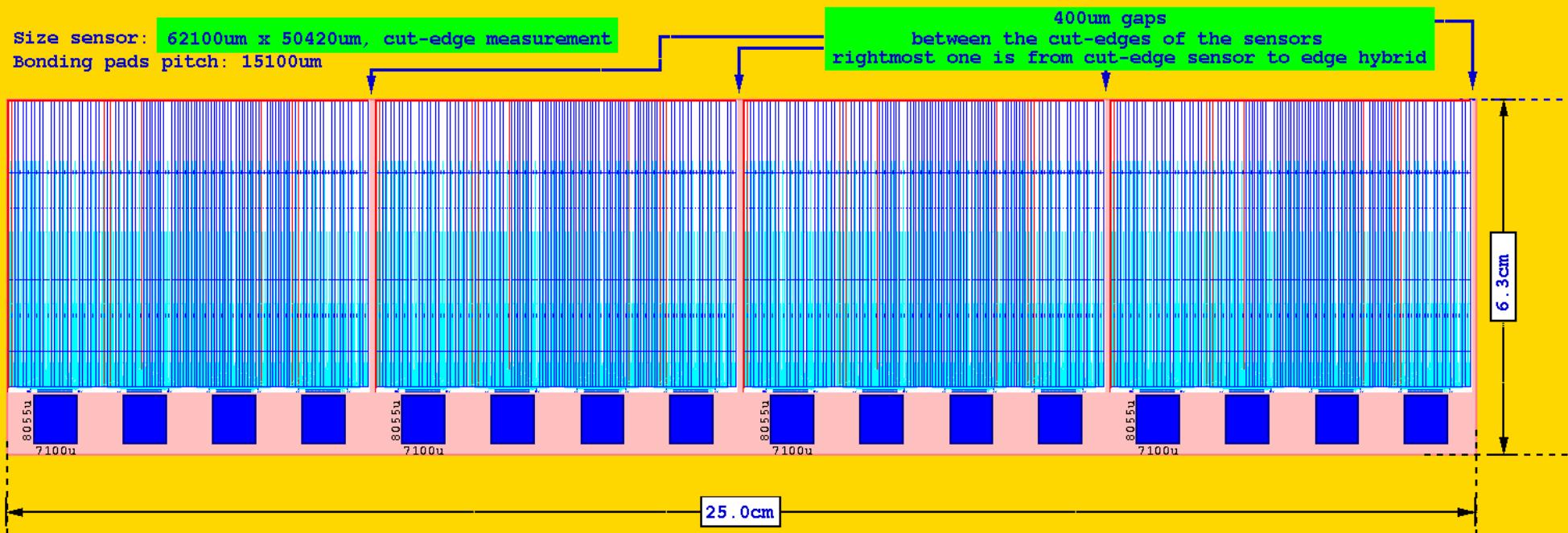


Gerrit van Nieuwenhuizen



IST prototype top view

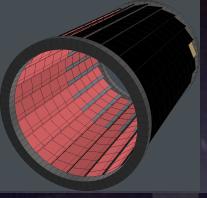
Prototype IST module using PHOBOS Inner Vertex sensors



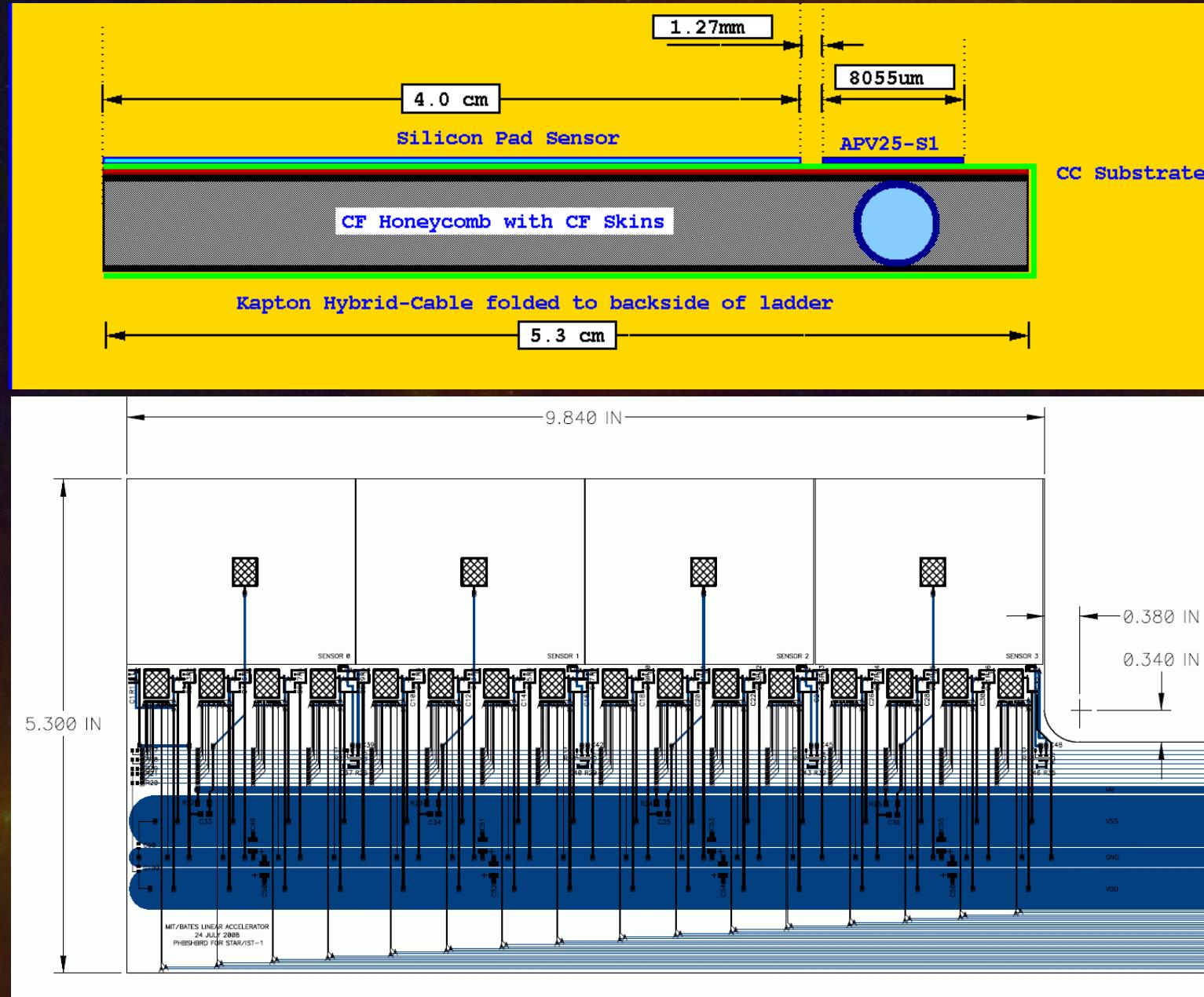
Extrapolating from Miro's preprototype kapton hybrid which had 6 APV25-S1 chips
Need about 1mm for each readout line pair (assuming 10mil/10mil line/interspacing)
Need about 0.762mm for Vss, Vd0 and Gnd lines per chip
Width needed for all the other lines is about 1.37mm per chip
Adds up to about 3.132mm hybrid width per chip
So, for 16 chips that means a hybrid width of at least 51mm. I've made it 6cm here

The final IST production hybrid will be 16cm and a bit long if we use 4cm x 4cm OR 8cm x 4cm sensors

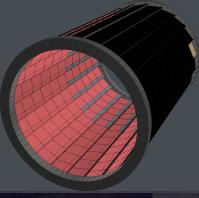
IST_Prototype_Module_TopView_06Jun2008
Latest Revision: 07/02/2008
Scale: 1cm = 0.8cm



IST prototype *amazing* folding hybrid



In production



IST prototype Carbon-Carbon plate

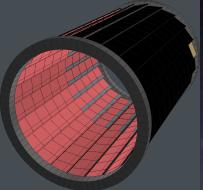


Carbon-Carbon is not usable

Finding out what went wrong

In mean time got some good C-C from Eric

Was cut by and sent to hybrid company



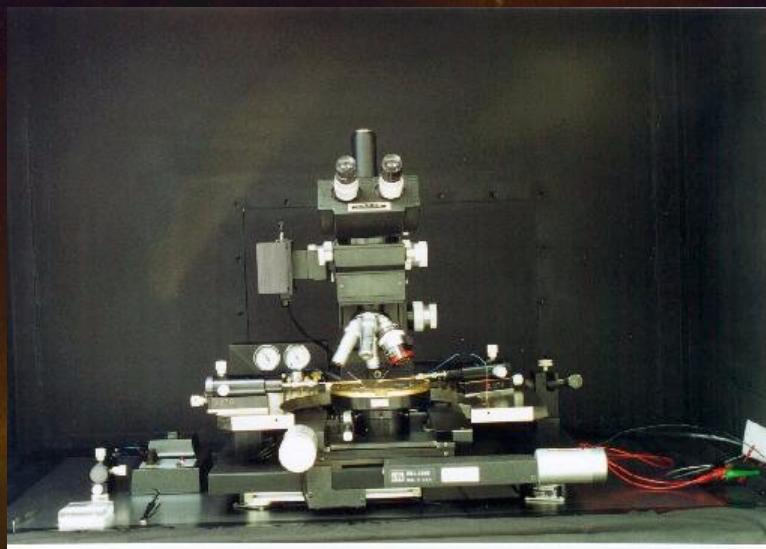
Bonding machine and Probe station



Hughes wire bonder has been serviced
and put back on service contract

Test bonding with 0.8 mil Al wire was
successful

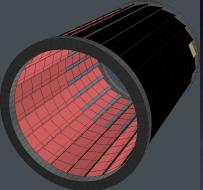
Test bonding on kapton is still under way



Alessi automatic probe station is, for the
most part, functional again

New controlling PC connected

Old LabView software operational
(minus database connectivity)

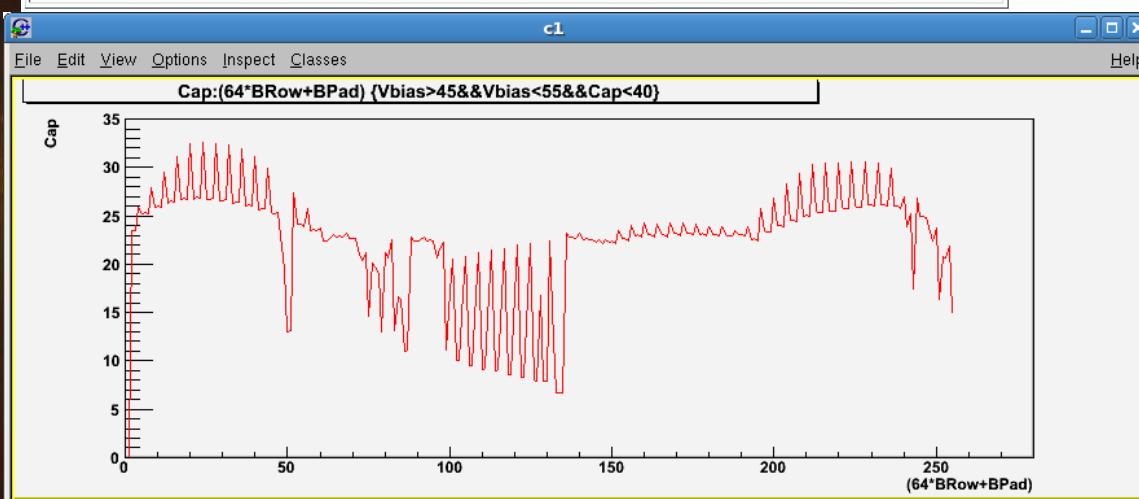
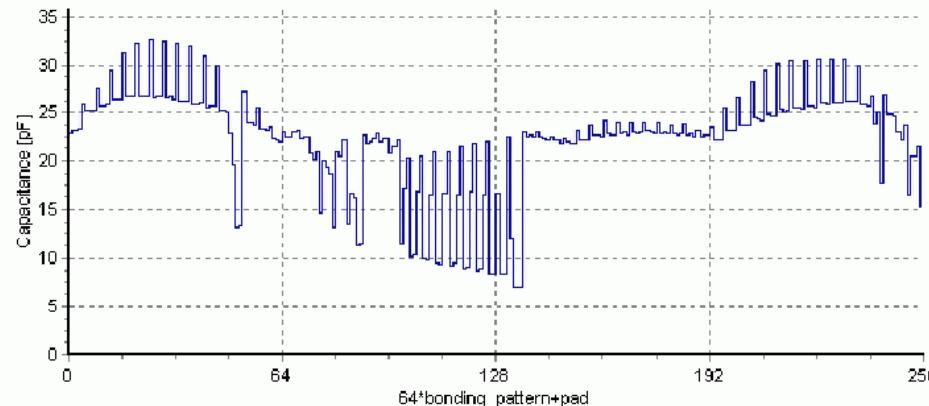


Probing sensor H70078-14

Batch H70078, sensor 14 (spectrometer type 5) Capacitance Distribution

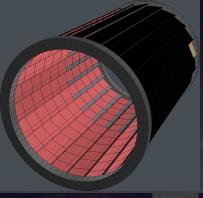
Measurement Date	7/22/1998 7:03:18 PM
Measurement Type	CV_Regular
Operator	Johannes
Operator's Comments	DEFAULT_MEASUREMENT
Temperature	22.8°C
Humidity	43 %

$V_b=99.8 [V]$

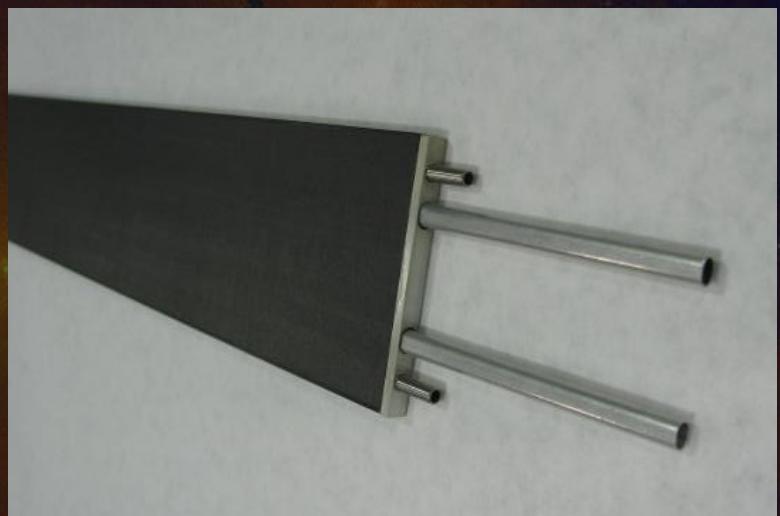
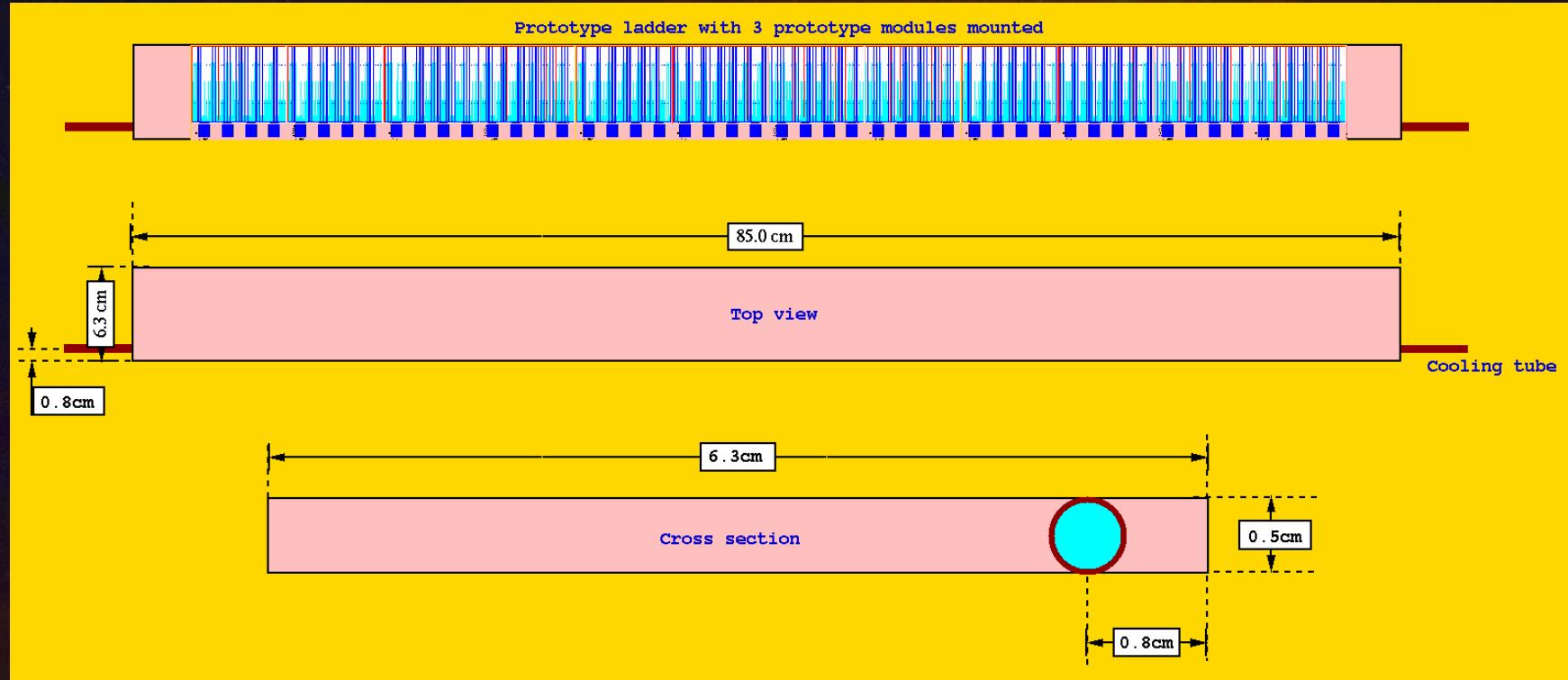


1998 CV measurement
from PHOBOS DB

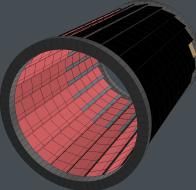
2008 CV measurement
with refurbished
probestation



IST Ladders and Mounting



In production at LBNL



IST Electrical Tasks, Miro

Supervise hybrid production, including laminating with C-C

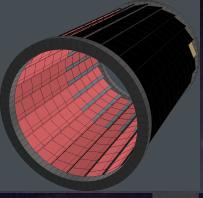
Supervise population of hybrids with passive components

Set up testing system for 16 APV hybrids

Test functionality of hybrids after mounting/bonding of APVs

Test functionality of hybrid after mounting of sensors

Pre-design of production hybrid, needed for sensor sizes



IST Technical Tasks, Dale

Assert full functionality of bonding machine

Wire bond pre-prototype = proof of principle

Fix remaining glitches in probe station

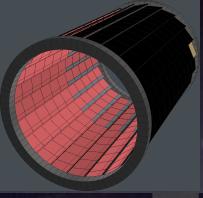
Mount and bond APV chips on several prototype hybrids

Mount and bond sensors on 1 prototype hybrid

Produce transport boxes for several prototype hybrids

Participate in full scale FGT thermal model

Participate in thermal tests for IST ladders



IST Mechanical Tasks, Jim

Implement IST designs in SolidWorks

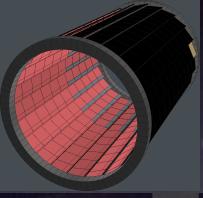
Integration plan for IST in the STAR inner tracking system

Look at mounting solutions for IST ladders

Design and supervise production of ladder support jigs

Transport boxes, bonding jigs?

Full FGT thermal model?



Notes

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